

GENII IDEAS[®]
GENII IDEAS Co., Ltd.

**2026 Q1
Investor Conference**

Ticker **7631**



Reflection



Innovation



Immediacy



Synergy

Disclaimer



- The information contained in this presentation is sourced from internal and external materials, including operational results, financial condition, business development and industry overview.
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- This presentation does not constitute investment advice. The Company assumes no responsibility for the accuracy or completeness of its contents, nor for any losses arising from reliance on this presentation.

Table Of Contents



01

Company Profile

02

**Business Strategy
& R&D Capability**

03

Product & Patent

04

Sustainable Action

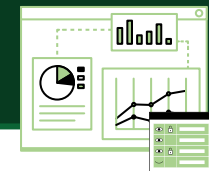
05

Financial Performance

01. Company Profile



General Information



Management

Mulder Tseng | Chairman
Eva Cheng | President



Established & Address

2018/01 | 9F, No. 231, Linsen Rd.
East Dist., Hsinchu City



IPO

2025/03/13



Employee

170+



Capital

NT\$ 201M



Facility Engineering

- High-Tech MEP Engineering
- Hook-up System Integration
- Gas Supply System Design



Equipment & Component Design and Development

- Piping & Mechanism R&D
- Process Parts & Consumables
- Total Tech Support



Tech Integration & Innovation

- Laser Tech Applications
- Smart Manufacturing
- Customized Solutions

Corporate Value & Operations



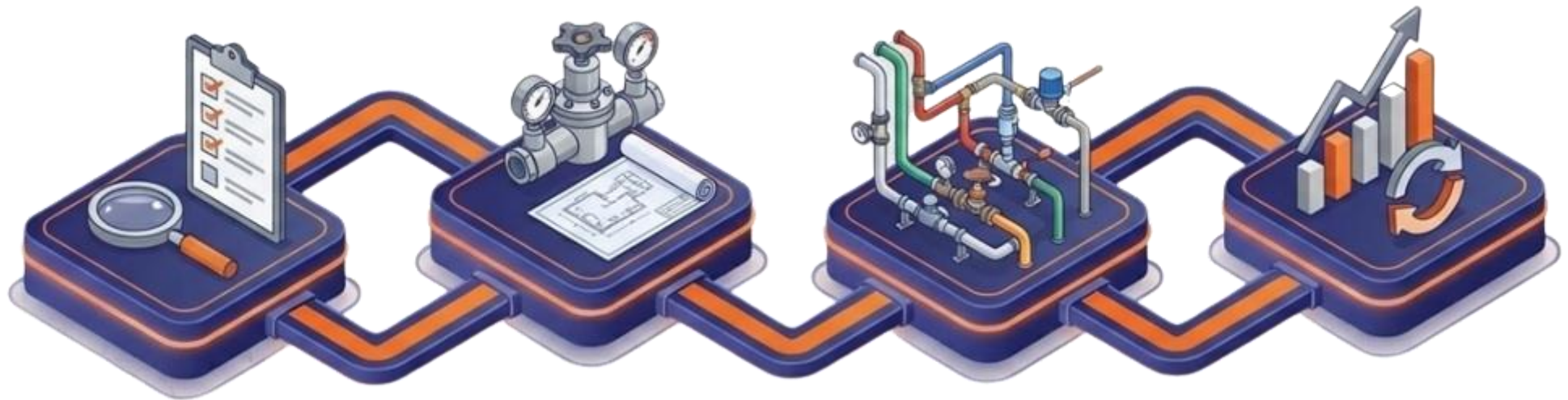
Cross-Disciplinary Key Tech Services & Innovative Products

Driven by User Needs & Problem Statements

Design, Development, & Manufacturing of Process Equipment Components and Consumables

Strategic Layout in High-Tech Facility MEP Supply Systems

Comprehensive After-Sales Service & Technical Support



Innovating & Optimizing Client Production Processes & Equipment

Guiding Improvements in Gas Hook-up Engineering & Installation

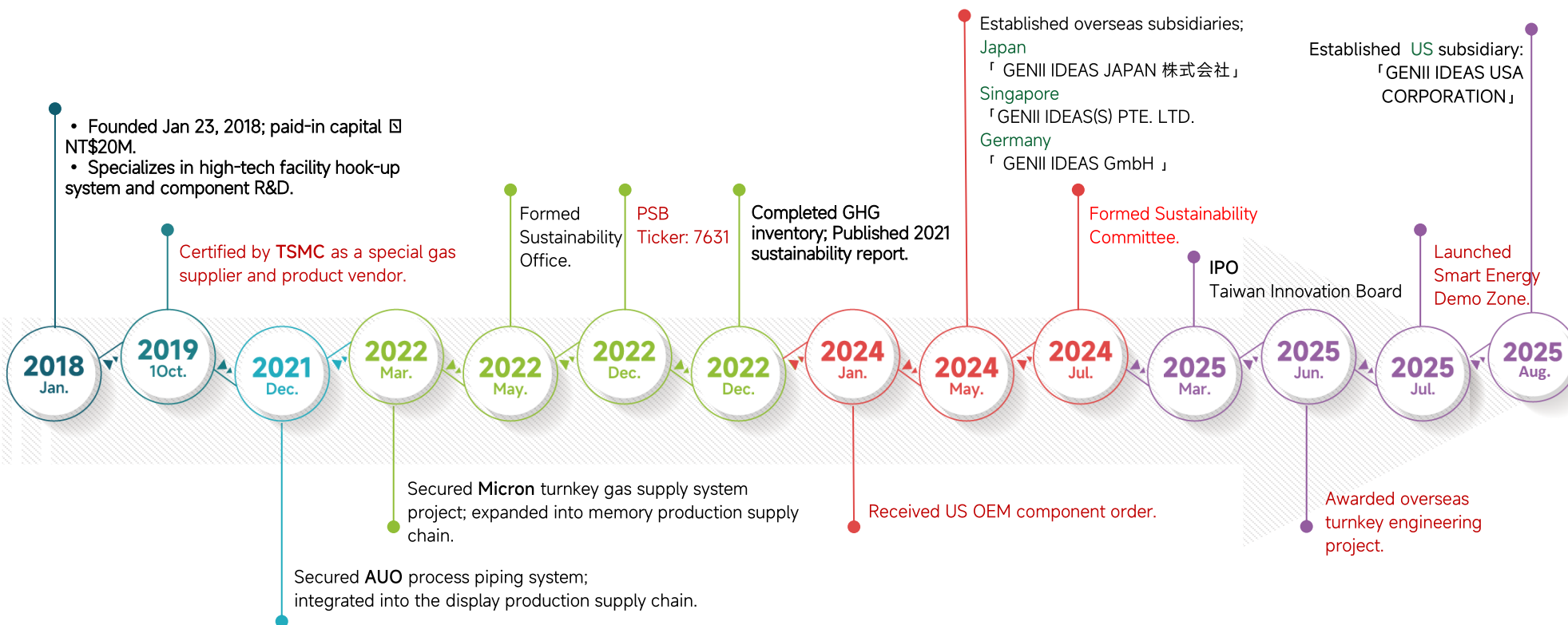
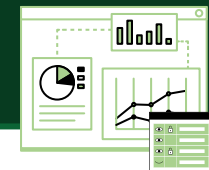




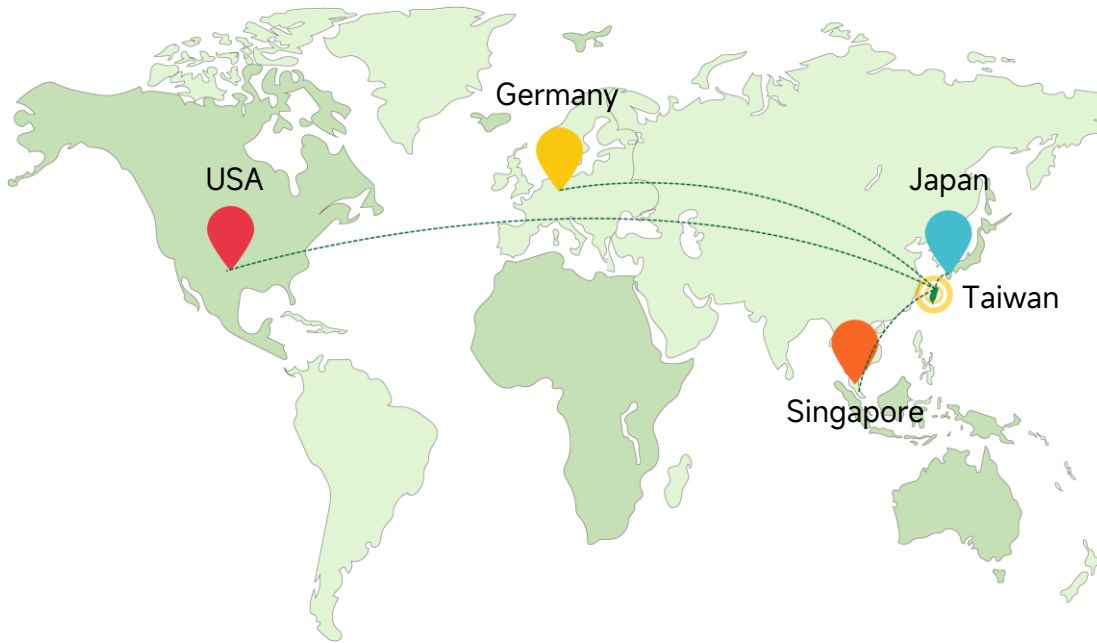
Responding to climate change and actions

「The Premier Service Provider For
High-Tech Equipment Optimization」

GENIIDEAS - Milestone

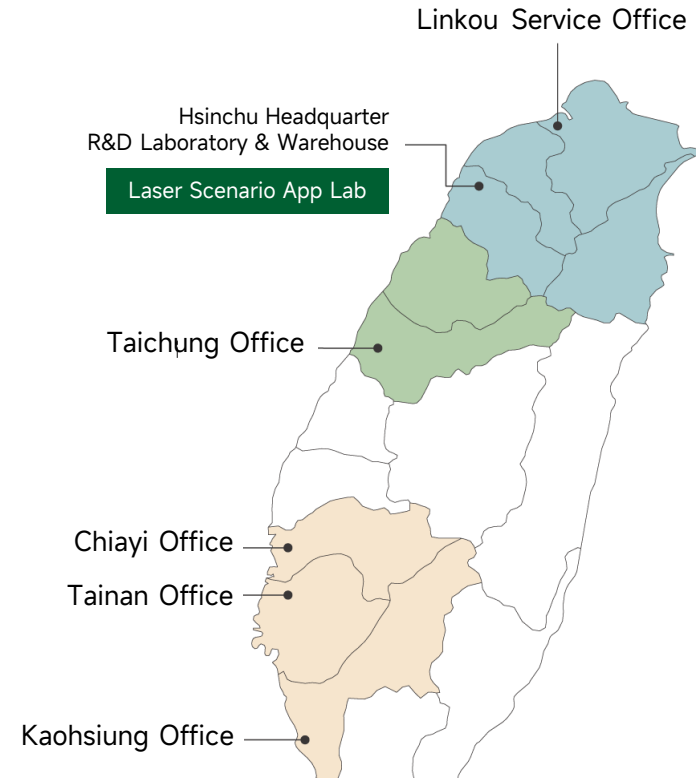


Global Network



Overseas Subsidiary

- Japan _, Kumamoto
- Germany _, Dresden
- Singapore
- USA _, Arizona



Taiwan Branch

- Hsinchu Science Park
- Central Taiwan Science Park
- Southern Taiwan Science Park

02. Business Strategy & R&D Capability



3rd-Gen Solar Tech: A New Era of Low-Carbon Self-Powered Systems



Integrating Smart Agriculture & Buildings to Create a Net-Zero Ecosystem

Smart Agriculture | Low-Carbon Self-Powered Greenhouse (Partnering with ITRI)

Agrioltaics Applying perovskite technology to greenhouses at the Shalun Green Energy site:

Low-carbon, green production for high-value crops.

Self-sufficient power to lower farm consumption.

Boosting ag-tech competitiveness toward 2050 Net-Zero.



Smart Architecture | Perovskite Energy-Generating Windows

From "Display" to "Daily Resource Circulation"

Upgrading Geniideas showroom windows for active power generation and energy efficiency:

Shading & Insulation

Reduces indoor temperature and A/C load.

Photovoltaic Conversion

Converts sunlight into stable power.

Power Supply

Powers all lighting in the showroom.





Resource Circularity & Low-Carbon Processes

Gas Recovery, Purification, and Reuse



Recycling and processing these gases into reusable resources.

Supercritical CO2 Cleaning & Extraction

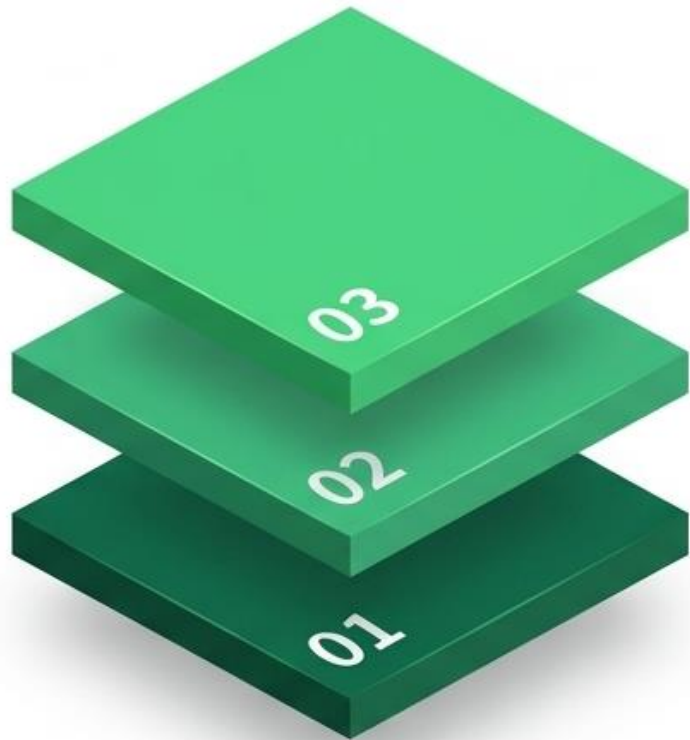


Leveraging the unique properties of supercritical CO2 for high-efficiency component cleaning or material extraction.

Core Tech: Solving Industry Pain Points



Building Competitive Edge through Tech Stacking



Cross-Disciplinary Applications

Laser Optics Materials Science Automation Machining

Complex integration creates high barriers to entry.

Full-Stack HW/SW Integration

Seamless connectivity between hardware and control systems for maximum synergy.

Proprietary Sustainable Solutions

Energy Saving Lightweight Materials Circular Recycling

Net-Zero alignment to drive client operational efficiency.

03. Product & Patent



Innovative Product: Genii LaserWelder



Genii LaserWelder Comprehensive Laser Welding System: Total Solutions from Small to Large Pipes Providing the Optimal Solution for Your Specific Needs



Smart Brain:
Human-Machine
Interface Controller
(HMI Controller)

Intuitive Graphical Interface:
Parameter Setting and
Real-time Monitoring



Energy Heart:
500W Fiber Laser
Main Unit

Superior Beam Quality:
Realizes High-speed, Low
Heat-Affected Zone Welding



Precision Hand:
Automated Laser Welding
Head Assembly

Open-and-Close Design:
Flexible Installation and Full
Circumferential
Rotation

Weld Quality Monitoring



Certification:
Passed 10,000 Fatigue
Tests and Airtightness Tests



F-Type (Small Diameter)



Pipe Diameter: 6A-25A (1/8" - 1")
Applications: Semiconductor
High-purity Gas Systems
Features: Lightweight and Flexible

E-Type (Medium Diameter)



Pipe Diameter: 32A - 100A
Applications: Semiconductor
Process Vacuum Systems
Features: Precision Laser Seam
Welding Technology

G-Type (Large Diameter)

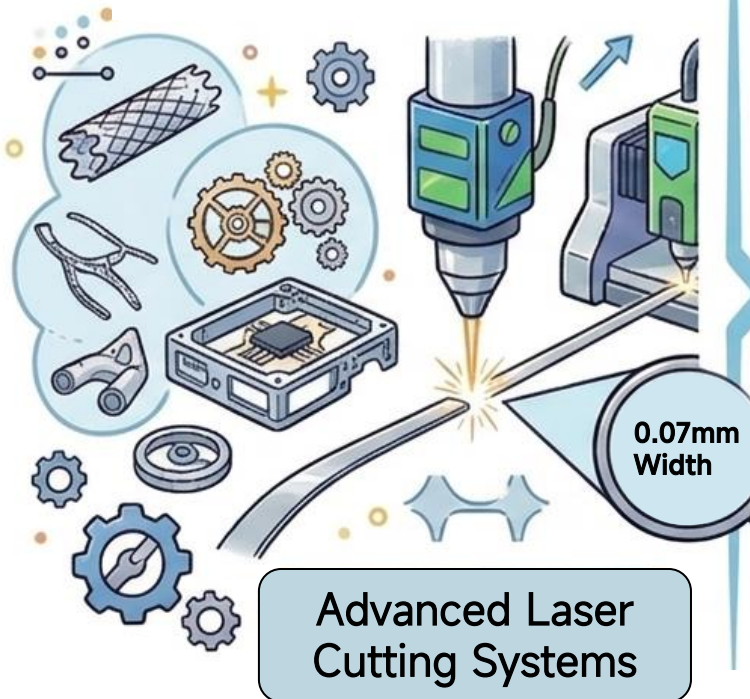


Pipe Diameter: 100A and above
Applications: Petrochemical,
Chemical, and Energy Industries
Features: Customization for Large
Pipelines

Customized Solutions: Cross-Industry Laser Applications

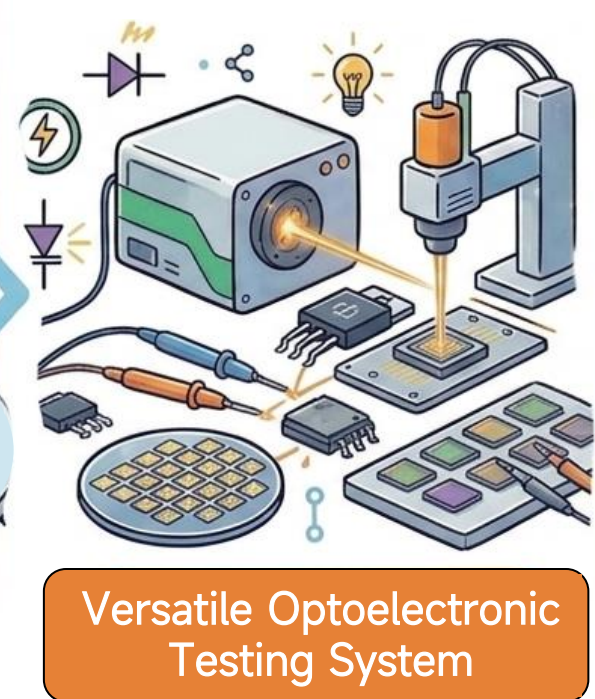


Ultra-Fine Metal Cutting



Advanced Laser Cutting Systems

Electrical Testing



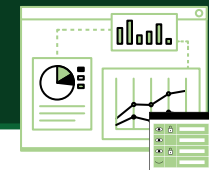
Versatile Optoelectronic Testing System

Precision Laser Glass Processing



Advanced Laser Glass Processing Systems

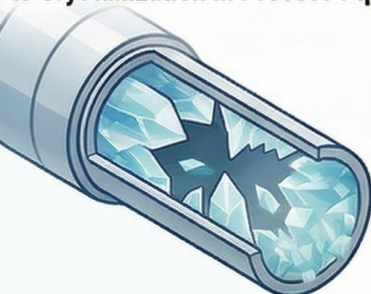
Creative Product – Pipeline Anti-Crystallization Vibration Device)



Pipeline Anti-Crystallization Vibration Device: Dual-Effect Solution

Core Pain Points & Innovative Countermeasures

Customer Pain Point: Clogging Due
to Crystallization in Process Pipelines

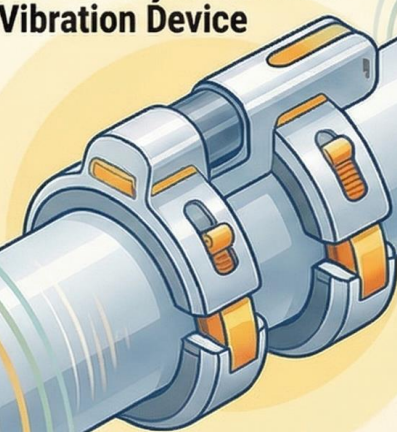


Traditional heating methods
have limited effectiveness
and high energy consumption.



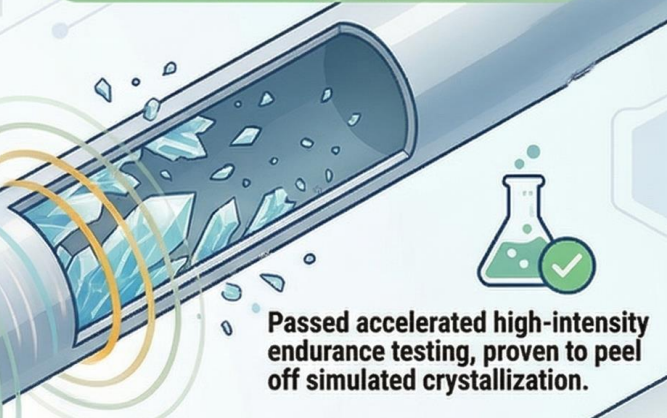
Dual-Effect Solution:
Vibration Delays Crystallization +
Acoustic Real-Time Detection

Pipeline Anti-Crystallization Vibration Device



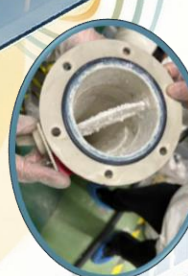
Utilizes clamp-on design,
does not impact existing pipelines,
and is easy to install.

Function 1: Mechanical Vibration,
Effectively Delays Crystallization



Passed accelerated high-intensity
endurance testing, proven to peel
off simulated crystallization.

Function 2: Acoustic Analysis,
Real-Time Clogging Monitoring



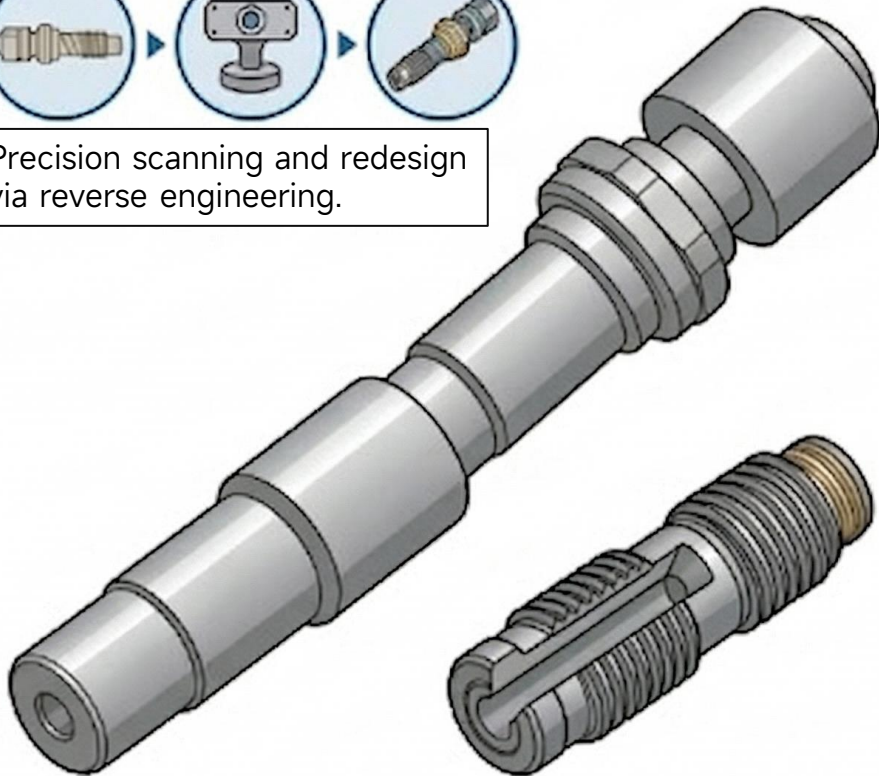
Converts clogging level to visualized
percentage. Recommended installation
within ± 50 cm of the clogging point.



01. Semiconductor Locating PINs



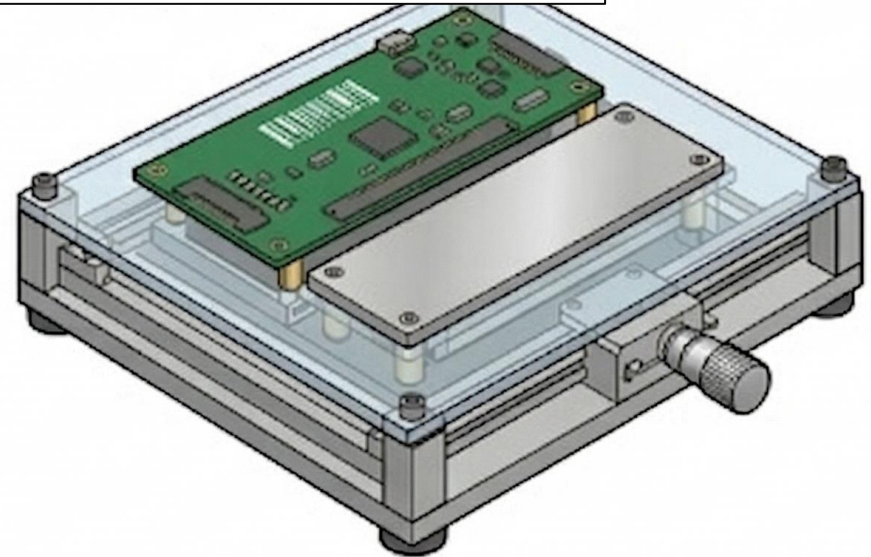
Precision scanning and redesign via reverse engineering.



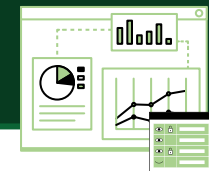
02. PCB Metrology Fixtures



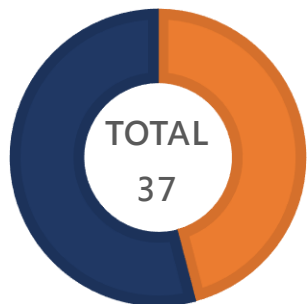
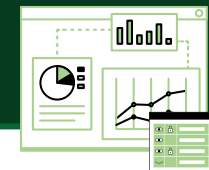
Custom fixture development tailored to client-specific precision requirements.



Global Technical Support & Service



Innovation & Patent Portfolio



TOTAL
37

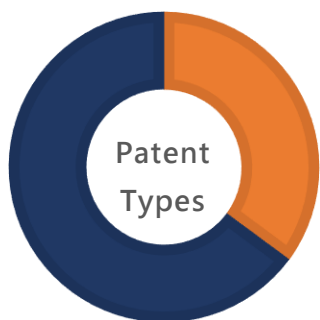
- Granted 46% (17 units)
- Pending 54% (20 units)

Valid Patents:

4 Invention Patents, 13 Utility Model Patents

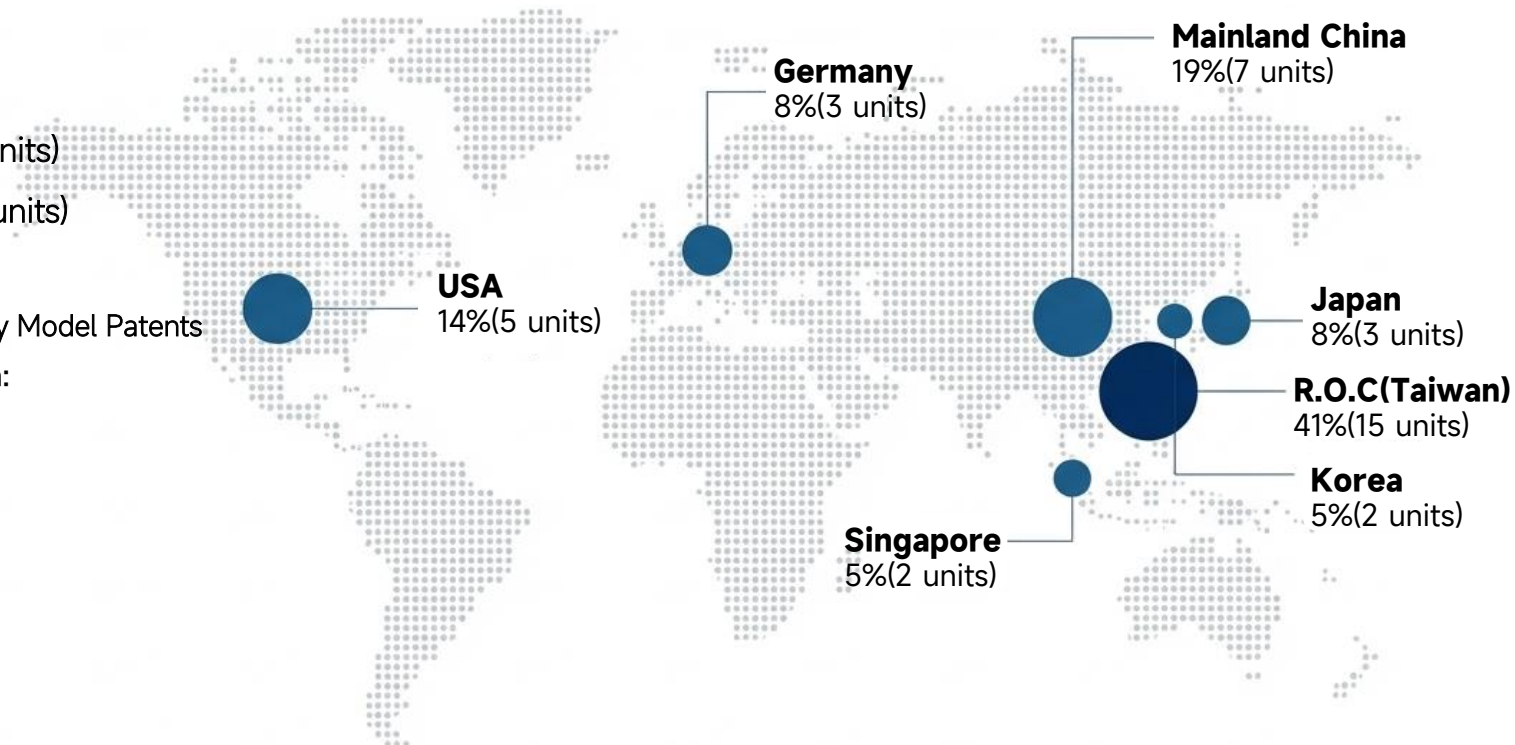
Patents under Examination:

20 Invention Patents



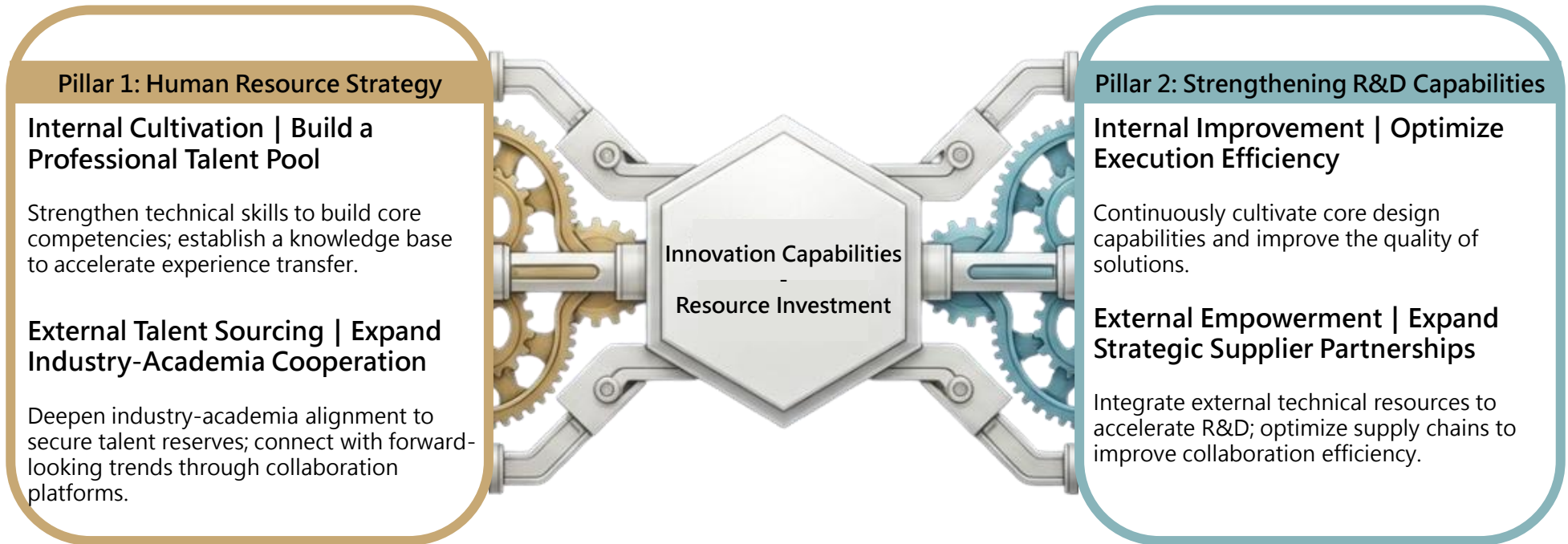
Patent
Types

- Utility Model Patents: 35% (13 units)
- Invention Patents: 65% (24 units)





Investing Resources for Future Layout



04. Sustainable Action



Sustainability Responsibility – Leveraging Core Value & Innovation Capability





Environmental Stewardship

- Go Paperless
- Energy conversion
- Green manufacturing
- Low-carbon commuting
- Sustainability Committee

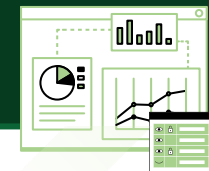
Corporate Governance

- EAP
- Gender equality
- On-the-job training
- Performance bonus
- Trade secret protection

Society Value

- Lohas leave
- Taiwan Spirit
- Charitable trust
- Volunteer leave
- I-A collaboration





2024 TSMC MM ESG Award



Supplier ESG Joint Proposal:
Excellence in Impact (5th Place)



Sustainability: Driving Innovation & Progress



Advancing Industry through Technology, Committed to Sustainability.

【【 Innovation 】】】



2025
Taiwan Innotech Expo (TIE) –
Invention Contest Bronze Medal

【【 ESG 】】】



2025 18th
TW Corporate Sustainability Awards (TCSA) –
Sustainability Report Bronze Award

05. Financial Performance



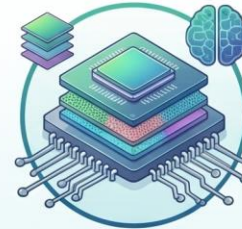
2026-2028 Semiconductor Industry Forecasts



Market Size & Growth Forecast



Key Technology Innovation



Advanced Packaging & Chiplet Heterogeneous Integration



2nm Node Adoption: EUV Lithography & GAA Transistors



Wide-Bandgap Materials: Growth in SiC & GaN Applications

End-Use Application Drivers



Automotive Electronics



High-Performance Computing



Network Communications

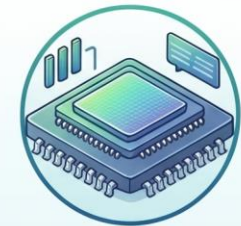
Supply Chain & Regional Development



Regional Reshoring: Localized Production



Supply Chain Resilience

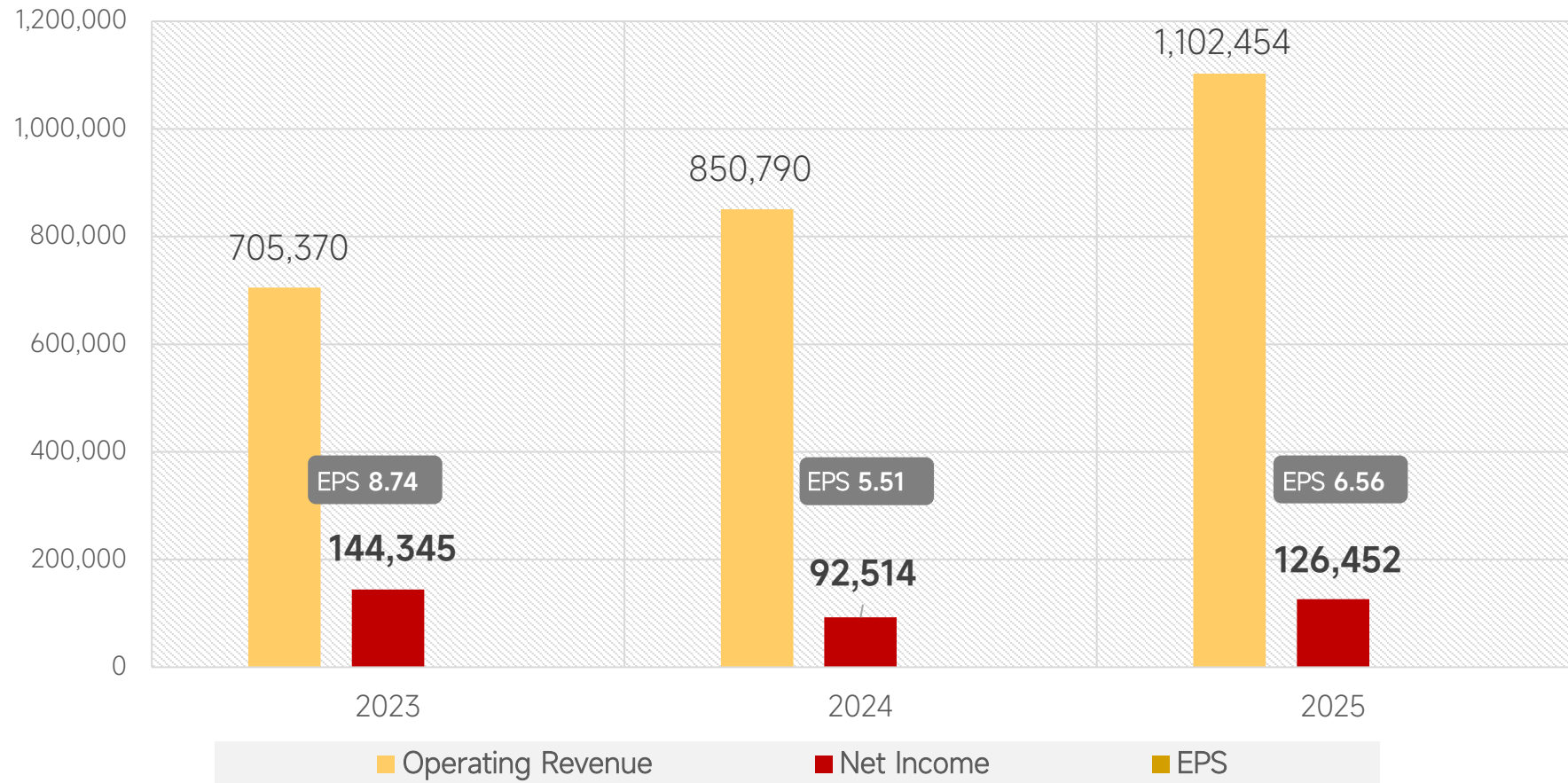


Fab Capacity Management

Source: Reference to domestic and international semiconductor and technology reports



2023~2025 Performance



Note: Financial data audited or reviewed by Ernst & Young CPA Firm.

Gross Profit Margin and Earnings Per Share



Statement of Comprehensive Income

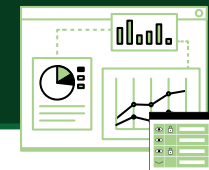
2023~2025

Unit: NT\$ Thousand

Item / Year	2023	2024	2025	YOY(%)
Operating Revenue	705,370	850,790	1,102,454	29.58%
<u>Gross Profit</u>	<u>39.93%</u>	<u>31.26%</u>	<u>27.52%</u>	<u>(11.96)%</u>
Operating Expenses	102,357	127,155	149,874	17.87%
Operating Income	179,304	138,813	153,593	10.65%
Operating Profit	25.42%	16.32%	13.93%	(14.64)%
Net Income	144,345	92,514	126,452	36.68%
Net Profit	20.46%	10.87%	11.47%	5.52%
<u>EPS(NTD)</u>	<u>8.74</u>	<u>5.51</u>	<u>6.56</u>	<u>19.06%</u>
ROE	34.82%	18.67%	18.72%	0.27%

Note: Financial data audited or reviewed by Ernst & Young CPA Firm.

Asset Position and Turnover Ratios



Balance Sheet

2023~2025

Unit: NT\$ Thousand

Item / Year	2023	2024	2025	YOY(%)
Cash And Cash Equivalents	255,325	208,743	610,574	192.50%
Accounts Receivable	79,003	192,543	99,413	(48.37)%
Inventories	340,996	400,201	486,005	21.44%
Total Assets	754,999	1,008,599	1,483,072	47.04%
Current Liabilities	253,107	340,945	478,222	40.26%
Non-current Liabilities	20,753	157,763	163,916	3.90%
Total Liabilities	273,860	498,708	642,138	28.76%
Key Financial Ratios				
Debt Ratio	36.27%	49.45%	43.30%	(12.44)%
Inventory Turnover(times)	1.29	1.58	1.80	13.92%
A/R Turnover (times)	6.23	6.27	7.55	20.41%

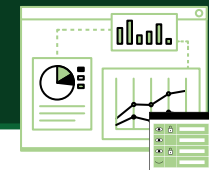
Note: Financial data audited or reviewed by Ernst & Young CPA Firm.



Quarterly Payouts

Balancing Growth & Stable Returns

Year	Cash Dividend (NT\$) / Payout Ratio
2024 Q1	0.50
2024 Q2	0.50
2024 Q3	0.59
2024 Q4	1.20
2024 Total	2.79 / 51%
2025 Q1	0.65
2025 Q2	0.74
2025 Q3	0.75
2025 Q4	1.60
2025 Total	3.74 / 59%



R&D Expenses as a Percentage of Revenue

Unit: NT\$ Thousand

Year	2023			2024			2025		
Company	R&D Expense	Operating Revenue	Ratio %	R&D Expense	Operating Revenue	Ratio %	R&D Expense	Operating Revenue	Ratio %
Geniideas	11,873	705,370	1.68	13,018	850,790	1.53	21,911	1,102,454	1.99
Wholetech	19,134	4,438,601	0.43	19,497	5,487,092	0.36	17,445	5,245,806	0.33
Rayzher	—	1,779,726	0.00	4,721	1,951,312	0.24	10,932	2,564,418	0.43

Data source:

Period financial reports of each company that have been audited and certified by independent CPAs..

Grateful for your resonance!

Let's laser-craft the future with GENIIDEAS.

Q & A



官方網站



2024 Sustainability Report

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